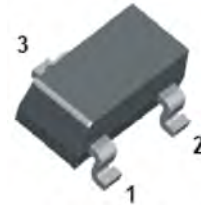


### Features

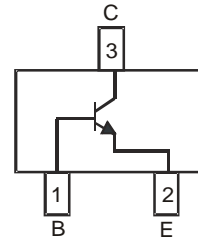
- Low Deviation in Base-Emitter Voltage
- Surface Mount Package
- Ideally Suited for Automated Assembly Processes
- **Lead Free by Design/RoHS Compliant (Note 1)**
- **"Green" Device (Note 2)**
- **Qualified to AEC-Q101 Standards for High Reliability**

### Mechanical Data

- Case: SOT-23
- Case material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: See Diagram
- Terminals: Finish - Matte Tin - annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.008 grams (approximate)



SOT-23



Schematic & Pin Configuration

### Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CB0</sub>	50	V
Collector-Emitter Voltage	V <sub>CE0</sub>	45	V
Emitter-Base Voltage	V <sub>EB0</sub>	6	V
Output Current - Continuous (Note 3)	I <sub>C</sub>	200	mA
Peak Collector Current	I <sub>CM</sub>	200	mA
Peak Emitter Current	I <sub>EM</sub>	200	mA
Power Dissipation (Note 3)	P <sub>d</sub>	300	mW
Power Deration	P <sub>der</sub>	2.4	mW/°C

### Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Ambient Air (Note 3)	R <sub>θJA</sub>	417	°C/W
Operating and Storage Junction Temperature Range	T <sub>j</sub> , T <sub>STG</sub>	-55 to +150	°C

- Notes:
1. No purposefully added lead.
  2. Diode's Inc.'s "Green" policy can be found on our website at [http://www.diodes.com/products/lead\\_free/index.php](http://www.diodes.com/products/lead_free/index.php).
  3. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on page 4 or on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.

# Electrical Characteristics: NPN Transistor @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 4)						
Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	50	—	—	V	$I_C = 10\mu A, I_E = 0$
Collector-Emitter Breakdown Voltage	$V_{(BR)CEO}$	45	—	—	V	$I_C = 1.0mA, I_B = 0$
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	6	—	—	V	$I_E = 10\mu A, I_C = 0$
Collector Cutoff Current	$I_{CEX}$	—	—	15	nA	$V_{CE} = 50V, V_{EB(OFF)} = 3.0V$
Base Cutoff Current ( $I_{BEX}$ )	$I_{BL}$	—	—	15	nA	$V_{CE} = 40V, V_{EB(OFF)} = 3.0V$
Collector-Base Cut Off Current	$I_{CBO}$	—	—	15	nA	$V_{CB} = 40V, I_E = 0$
				5	$\mu A$	$V_{CB} = 30V, T_A = 150^{\circ}C$
Collector-Emitter Cut Off Current, $I_{O(OFF)}$	$I_{CEO}$	—	—	50	nA	$V_{CE} = 40V, I_B = 0$
Emitter-Base Cut Off Current	$I_{EBO}$	—	—	50	nA	$V_{EB} = 5V, I_C = 0$
ON CHARACTERISTICS (Note 4)						
DC Current Gain	$h_{fe}$	180	—	—	—	$V_{CE} = 5V, I_C = 100\mu A$
		150	—	—	—	$V_{CE} = 5V, I_C = 500\mu A$
		220	—	—	—	$V_{CE} = 5V, I_C = 1mA$
		220	—	—	—	$V_{CE} = 5V, I_C = 2mA$
		150	—	—	—	$V_{CE} = 5V, I_C = 5mA$
		150	—	—	—	$V_{CE} = 5V, I_C = 10mA$
Collector-Emitter Saturation Voltage	$V_{CE(SAT)}$	—	0.09	0.18	V	$I_C = 10mA, I_B = 0.5mA$
		—	0.2	0.4	V	$I_C = 100mA, I_B = 5mA$
Base-Emitter Turn-On Voltage	$V_{BE(ON)}$	647	657	667	mV	$V_{CE} = 5V, I_C = 2mA$
Base-Emitter Saturation Voltage	$V_{BE(SAT)}$	—	—	0.8	V	$I_C = 10mA, I_B = 0.5mA$
		—	—	0.9	V	$I_C = 100mA, I_B = 5mA$
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	$C_{OBO}$	—	3	—	pF	$V_{CB} = 5.0V, f = 1.0\text{ MHz}, I_E = 0$
Input Impedance	$h_{ie}$	—	4.5	—	$K\Omega$	$V_{CE} = 5.0V, I_C = 2mA, f = 1.0KHz$
Voltage Feedback Ratio	$h_{re}$	—	2	—	$\times 10E-4$	
Small Signal Current Gain	$h_{fe}$	—	200	—	—	
Output Admittance	$h_{oe}$	—	30	—	$\mu S$	
Current Gain-Bandwidth Product	$f_T$	100	—	—	MHz	$V_{CE} = 20V, I_C = 10\text{ mA}, f = 100\text{ MHz}$
Noise Figure	NF	—	—	10	dB	$V_{CE} = 5V, I_C = 100\mu A, R_S = 1K\Omega, f = 1kHz$

Notes: 4. Short duration pulse test used to minimize self-heating effect.

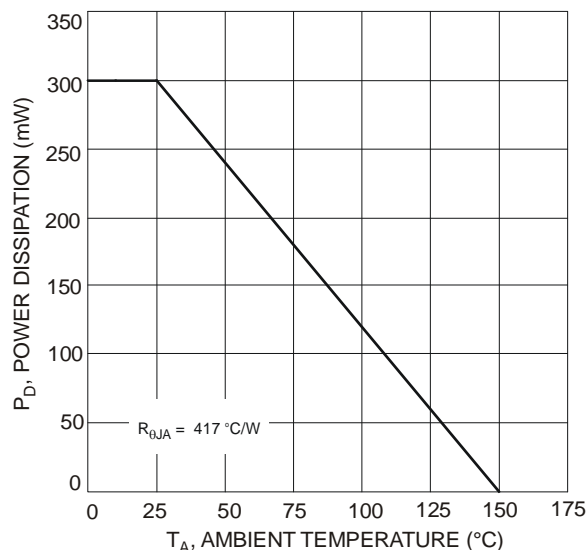


Fig. 1 Maximum Power Dissipation vs. Ambient Temperature

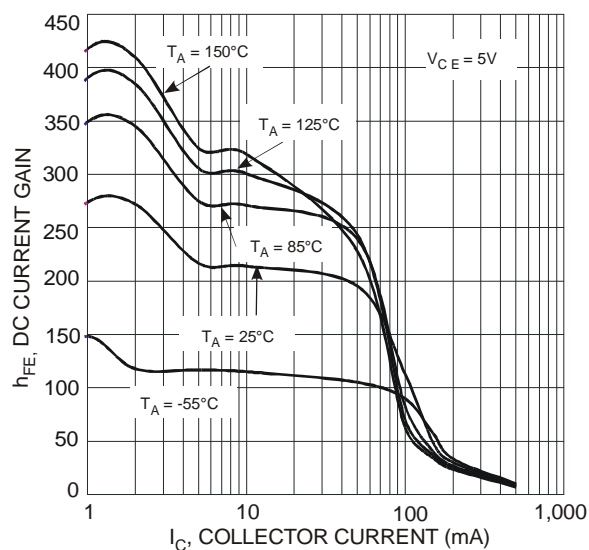
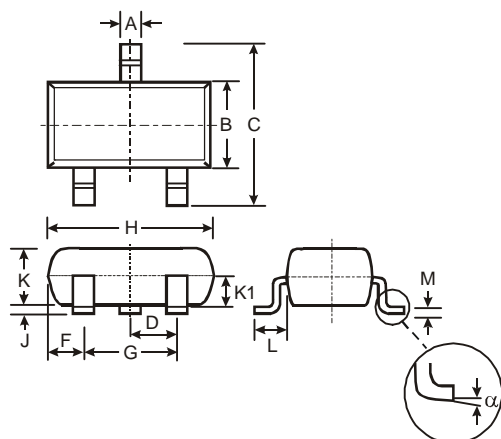


Fig. 2 Typical h<sub>FE</sub> vs. I<sub>C</sub>

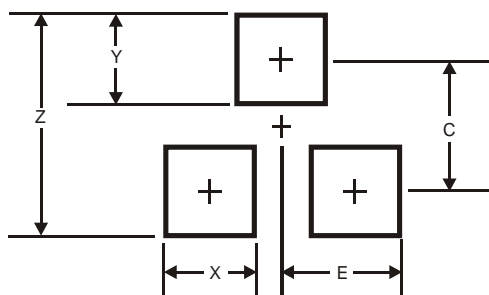


## Mechanical Details



SOT-23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.903	1.10	1.00
K1	-	-	0.400
L	0.45	0.61	0.55
M	0.085	0.18	0.11
$\alpha$	0°	8°	-
All Dimensions in mm			

## Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35

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